INNOLUME

Specification

FBA102YB08PM400MXXXX

Fiber Bragg Grating wavelength locked High Power Laser Diode

STORE STORES

Features:

- Kink-free operation up to 400mW
- Any wavelengths available in the range 1018-1022nm
- Custom wavelength tolerance and bandwidth on request
- · Individual burn-in and thermal cycling screening
- · Proprietary mirror coating technology enabling high reliability
- Built-in monitor photodiode (optional)
- 900um loose tube on fiber (optional)

Applications:

Recommended Operating Conditions				
@ CW, the case is mounted on room temperature heatsink				
Parameter	Min.	Тур.	Max.	Unit
Chip Temperature*	20	25	30	°C
Forward Current		800	900	mA
Output Power**	20		400	mW

 $\ensuremath{^*}$ may vary depending on the selected wavelength

** kink-free over the entire range

Characteristics				
@ CW, 25°C*, 800mA				
Parameter	Min.	Тур.	Max.	Unit
Forward Current @ 400mW			900	mA
Forward Voltage		1.7	2	V
Threshold Current		70	120	mA
Mean Wavelength (chosen by customer)	1018		1022	nm
Mean Wavelength Tolerance			±2	nm
Bandwidth (FWHM)**		0.08	0.1	nm
Wavelength shift with FBG temperature		0.01		nm/°C
Polarisation Extinction Ratio (PER)	15	17		dB
Polarisation		TE		

* specific chip temperature mentioned in individual test report (may vary depending on selected wavelength)

** resolution 20pm

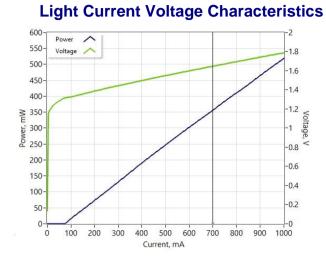
Absolute Maximum Ratings

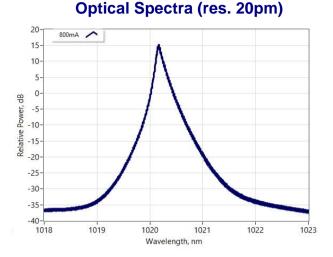
Parameter	Min	Мах	Unit
Forward Current		1000	mA
Reverse Voltage		2	V
TEC Current		3	А
TEC Voltage		4	V
Chip Operating Temperature	5	40	°C
Case Operating Temperature	0	70	°C
Pin Soldering Temperature (max 10 sec, max case temperature 120°C)		300	°C
Storage Temperature	-40	85	°C
FBG Operating Temperature	-40	85	°C
Fiber Band Radius	3		cm

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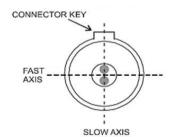
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Typical Performance (for reference only)





Thermistor spec	ification		Fiber specification			
Parameters	Value	Unit	Parameters	Value	Value	Unit
Туре	NTC		Fiber Type	HI1060	PM980	
Resistance @ 25°C	10±0.1	kOhm	Numerical Aperture (Typical)	0.14	0.12	
Beta 25-85°C	3435±1%	К	Cut-off Wavelength	920±50	900±70	nm
8-T Cl			Mode-Field (core) Diameter	6.2±0.3 @1060nm	6.6±0.3 @1060nm	μm
u 20000		_	Cladding Diameter	125±1	125±1	μm
15000 10000			Coating (buffer) Diameter	245±15	245±15	μm
10000 5000			Loose Tube Diameter (optional)	900	900	μm
0			Connector	FC/APC	FC/APC	
5 10 15 20 25 Tempe	30 35 40 45 50 erature, C	55 60	Кеу	narrow	narrow	



The output light is polarized along the slow axis of PM fiber.

Part-number Identification

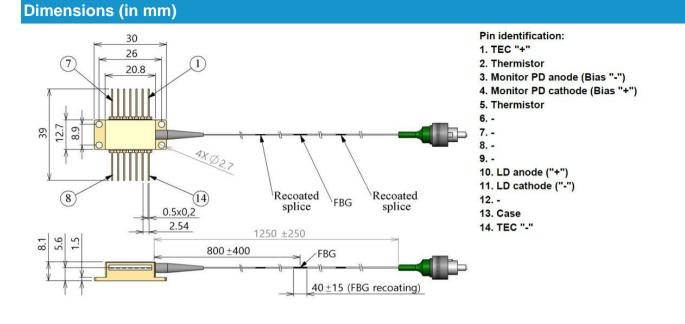
FBA1022B40PM400MXXXX -> 400mW output power at 1022nm mean wavelength, PM980 fiber FBA1022B40HI400MFXXX -> 400mW output power at 1022nm mean wavelength, HI1060 fiber, with built-in monitor photodiode

FBA1018B40HI400MLXXX -> 400mW output power at 1018nm mean wavelength, HI1060 fiber, with loose tube FBA1018B40PM400MFLXX -> 400mW output power at 1018nm mean wavelength, PM980 fiber, with built-in monitor photodiode and with loose tube

NOTE: Innolume product specifications are subject to change without notice

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Specification



Safety and Operating Instructions

The light emitted from this device is invisible and can be harmful to the human eye. Avoid looking directly into the fiber connector when the device is in operation. Proper laser safety eyewear must be worn during operation with open connector. Absolute Maximum Ratings may be applied to the device for short period of time only. Exposure to maximum ratings for extended period of time or exposure to more than one maximum rating may cause damage or affect the reliability of the device. Operating the device outside of its maximum ratings may cause device failure or a safety hazard. Power supplies used with the component must be employed such that the maximum forward current cannot be exceeded.

A proper heatsink for the device on thermal radiator is required. The device must be mounted on radiator with 4 screws (bolt down in X-style fashion with initial torque set to 0.075Nm and final X-style bolt down at 0.15Nm) or with clamps. The deviation from flatness of radiator surface must be less than 0.05mm. It's recommended using of Indium foil or thermal conductive and soft material between bottom of the case and heatsink for thermal interface. It's undesirable to use thermal grease for this. Avoid back reflection to the device. It may give impact on the device performance in aspects of spectrum and power stability. It also may cause fatal facet damage. Using of optical isolators is highly recommended to block back reflection.

Do not pull the fiber. Do not bend a fiber with a radius smaller than 3 cm. Fiber tip should always be protected from any contamination or damage during the process of installation. After removing the dust-preventing cap covered at fiber tip, carefully clean fiber tip by wiping through one direction using optical lens cleaning paper or cotton swab dabbed with Iso-Propanol or Ethyl alcohol. Operate the device with clean fiber connector only.

Electrostatic discharge is the primary cause of unexpected product failure. Take extreme precaution to prevent ESD. During device installation, ESD protection has to be maintained - use wrist straps, grounded work surfaces and rigorous antistatic techniques when handling the product.

